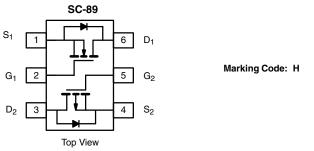


Vishay Siliconix

Complementary N- and P-Channel 60 V (D-S) MOSFET

PRODUCT	DUCT SUMMARY					
	V _{DS} (V)	R_{DS(on)} (Ω)	I _D (mA)			
N-Channel	60	1.40 at V _{GS} = 10 V	500			
N-Channel	60	3 at V _{GS} = 4.5 V	200			
P-Channel	- 60	4 at V _{GS} = - 10 V	- 500			
F-Griannei	- 00	8 at V _{GS} = - 4.5 V	- 25			



Ordering Information: Si1029X-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFETs
- Very Small Footprint
- High-Side Switching
- Low On-Resistance: N-Channel, 1.40 Ω
 P-Channel, 4 Ω
- Low Threshold: ± 2 V (typ.)
- Fast Switching Speed: 15 ns (typ.)
- Gate-Source ESD Protected: 2000 V
- Compliant to RoHS Directive 2002/95/EC

BENEFITS

- Ease in Driving Switches
- Low Offset (Error) Voltage
- Low-Voltage Operation
- High-Speed Circuits

APPLICATIONS

- Replace Digital Transistor, Level-Shifter
- Battery Operated Systems
- Power Supply Converter Circuits

			N-0	Channel	P-Channel			
Parameter		Symbol	5 s	Steady State	5 s	Steady State	Uni	
Drain-Source Voltage		V _{DS}		60	- 60		V	
Gate-Source Voltage		V _{GS}		± 2	0		V	
	T _A = 25 °C		320	305	- 200	- 190	_	
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 85 °C	I _D	230	220	- 145	- 135		
Pulsed Drain Current ^b		I _{DM}	650		- 650		mA	
Continuous Source Current (Diode Conduc	Source Current (Diode Conduction) ^a		450	380	- 450	- 380		
	T _A = 25 °C	Р	280	250	280	250	mW	
Maximum Power Dissipation ^a	T _A = 85 °C	P _D	145	130	145	130		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150				°C	
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000				V	

Notes:

a. Surface mounted on FR4 board.

b. Pulse width limited by maximum junction temperature.

Si1029X

Vishay Siliconix



Parameter	Symbol	Test Conditions		Min.	Тур.	Max.	Uni
Static		L					
	l	V _{GS} = 0 V, I _D = 10 μA	N-Ch	60			
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -10 \mu A$	P-Ch	- 60			
		$V_{DS} = V_{GS}, I_D = 250 \mu A$	N-Ch	1		2.5	- V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	P-Ch	- 1		- 3.0	
			N-Ch	•		± 50	
		$V_{DS} = 0 V, V_{GS} = \pm 5 V$	P-Ch			± 100	
ate-Body Leakage	I _{GSS}		N-Ch			± 150	-
		$V_{DS} = 0 V, V_{GS} = \pm 10 V$	P-Ch			± 200	
		V _{DS} = 50 V, V _{GS} = 0 V	N-Ch			10	nA
		$V_{DS} = -50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = -50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	P-Ch			- 25	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 85 \text{ °C}$	N-Ch			100	
						-	
		$V_{DS} = -50 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 \text{ °C}$	P-Ch	500		- 250	
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}$	N-Ch	500			-
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$	P-Ch	- 50			– mA
	(-)	$V_{DS} = 7.5 \text{ V}, \text{ V}_{GS} = -4.5 \text{ V}$	N-Ch	800			
		V _{DS} = - 10 V, V _{GS} = - 10 V	P-Ch	- 600			
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$	N-Ch			3	Ω
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 25 mA	P-Ch			8	
Drain-Source On-State		V _{GS} = 10 V, I _D = 500 mA	N-Ch			1.40	
Resistance ^a		V _{GS} = - 10 V, I _D = - 500 mA	P-Ch			4	
		V_{GS} = 10 V, I _D = 500 mA, T _J = 125 °C	N-Ch			2.50	
		V_{GS} = - 10 V, I _D = - 500 mA, T _J = 125 °C	P-Ch			6	
	d,	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$	N-Ch		200		ms
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 100 mA	P-Ch		100		
	V	I _S = 200 mA, V _{GS} = 0 V	N-Ch			1.4	V
Diode Forward Voltage ^a	V _{SD}	I _S = - 200 mA, V _{GS} = 0 V	P-Ch			- 1.4	
Dynamic ^b							
			N-Ch		750		
Total Gate Charge	Qg	N-Channel	P-Ch		1700		-
	<u> </u>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 250 \text{ mA}$	N-Ch		75		
Gate-Source Charge	Q _{gs}	P-Channel	P-Ch		260		pC
	0	$V_{DS} = -30 \text{ V}, V_{GS} = -15 \text{ V}, I_{D} = -500 \text{ mA}$	N-Ch		225		
Gate-Drain Charge	Q _{gd}		P-Ch		460		
lanut Canaditanaa	0		N-Ch		30		
Input Capacitance	C _{iss}	N-Channel	P-Ch		23		pF
Output Capacitance	C	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz	N-Ch		6		
Ouipul Capacitance	C _{oss}	P-Channel	P-Ch		10		
Reverse Transfer Capacitance	C _{rss}	$V_{DS} = -25 V$, $V_{GS} = 0 V$, f = 1 MHz	N-Ch		3		
	Orss		P-Ch		5		
Turn-On Time ^c	t _{ON}	N-Channel V_{DD} = 30 V, R _L = 150 Ω	N-Ch		15		ns
	-010	$I_D \cong 200 \text{ mA}, V_{GEN} = 10 \text{ V}, R_g = 10 \Omega$	P-Ch		20		
		P-Channel V _{DD} = - 25 V, R _I = 150 Ω	N-Ch		20		
Turn-Off Time ^c	t _{OFF}						

Notes:

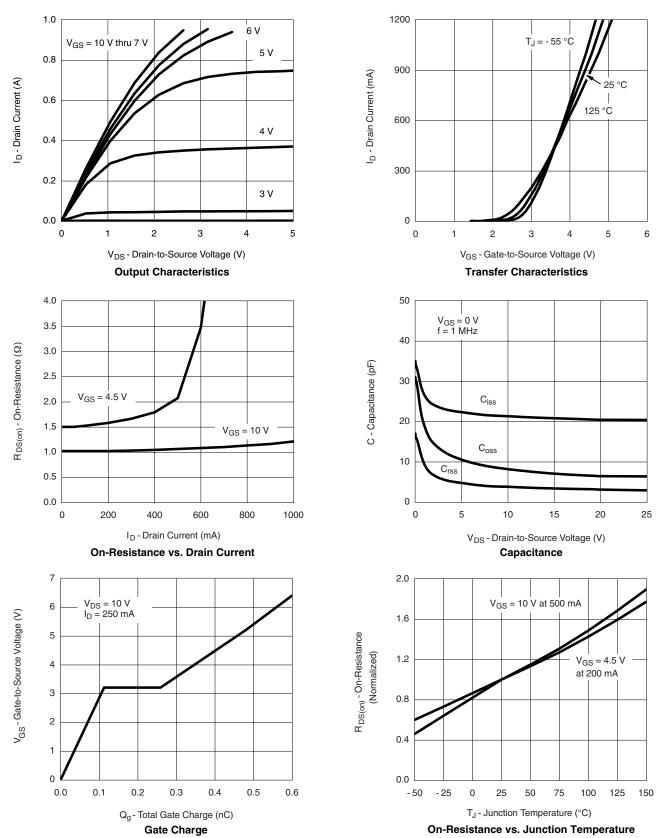
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

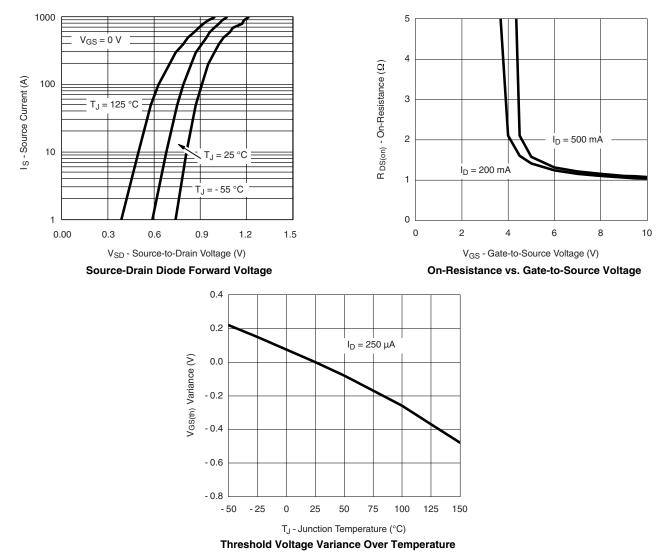


N-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



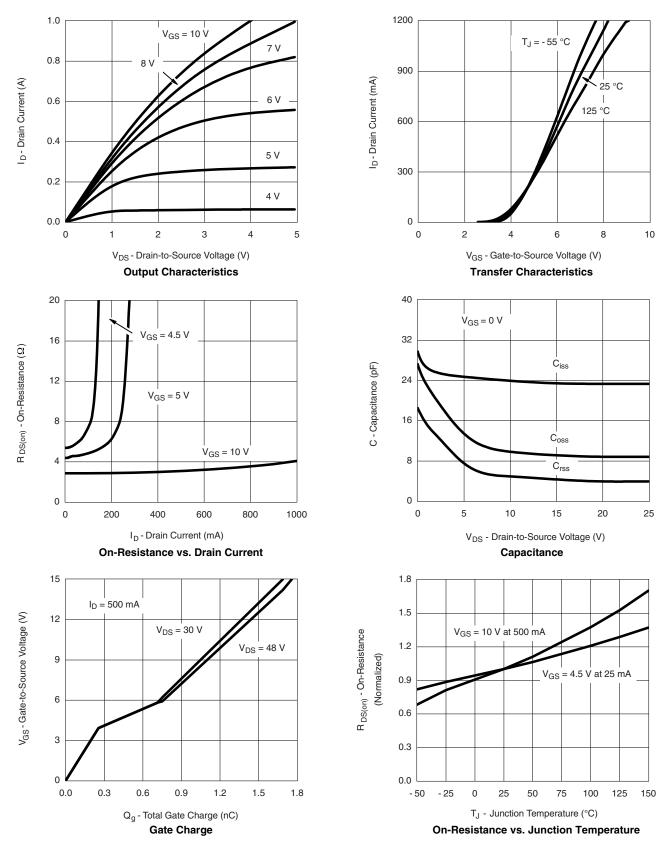


N-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)





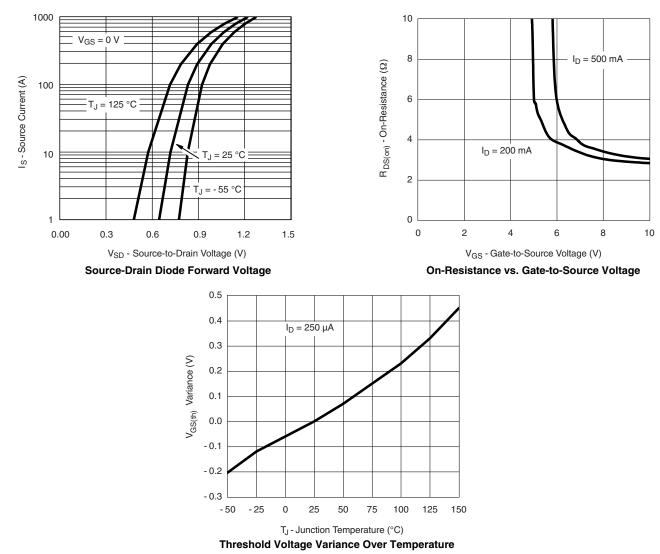
P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Document Number: 71435 S10-2432-Rev. C, 25-Oct-10



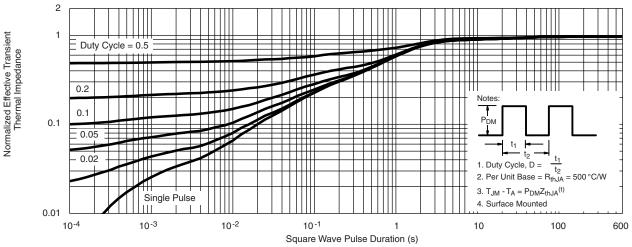
P-CHANNEL TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



6



N- OR P-CHANNEL TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



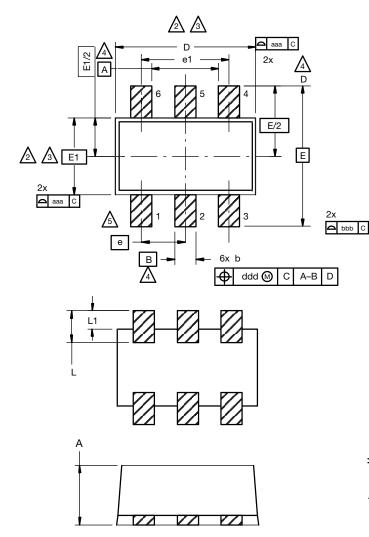
Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71435.



Vishay Siliconix

SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

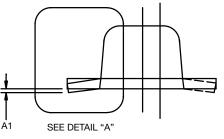
 \triangle Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS					
	MIN.	NOM.	MAX.			
А	0.56	0.58	0.60			
A1	0	0.02	0.10			
b	0.15	0.22	0.30			
С	0.10	0.14	0.18			
D	1.50	1.60	1.70			
E	1.50	1.60	1.70			
E1	1.15	1.20	1.25			
е	0.45	0.50	0.55			
e1	0.95	1.00	1.05			
L	0.25	0.35	0.50			
L1	0.10	0.20	0.30			
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14					

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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